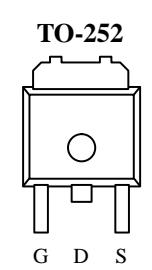


P-Channel Enhancement-Mode Transistor

Product Summary

| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ (Ω) | I_D^a (A) |
|-------------------|---------------------------|-------------|
| -60 | 0.28 @ $V_{GS} = 10$ V | ± 10 |

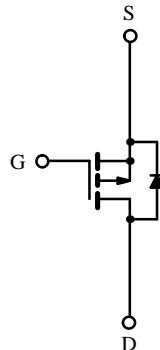
175°C Rated
Maximum Junction Temperature



Drain Connected to Tab

Top View

Order Number:
SMD10P06



P-Channel MOSFET

Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Limit | Unit |
|-----------------------------------------------------------|----------------|------------------|------|
| Drain-Source Voltage | V_{DS} | -60 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current ^b | I_D | -10 | A |
| | | -5.7 | |
| Pulsed Drain Current (maximum current limited by package) | I_{DM} | -16 | A |
| Continuous Source Current (Diode Conduction) ^a | I_S | -2.0 | |
| Maximum Power Dissipation | P_D | 42 | W |
| | | 2.0 ^b | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 to 175 | °C |

Thermal Resistance Ratings

| Parameter | Symbol | Limit | Unit |
|-------------------------------------------|------------|-------|------|
| Junction-to-Ambient Free Air ^b | R_{thJA} | 60 | °C/W |
| Junction-to-Case | R_{thJC} | 3.0 | |

Notes:

- a. Calculated Rating for $T_C = 25^\circ\text{C}$, for comparison purposes only. This cannot be used as continuous rating (see Absolute Maximum Ratings and Typical Characteristics).
- b. Surface Mounted on FR4 Board, $t \leq 10$ sec.

Subsequent updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #1480.

SMD10P06

TEMIC
Semiconductors

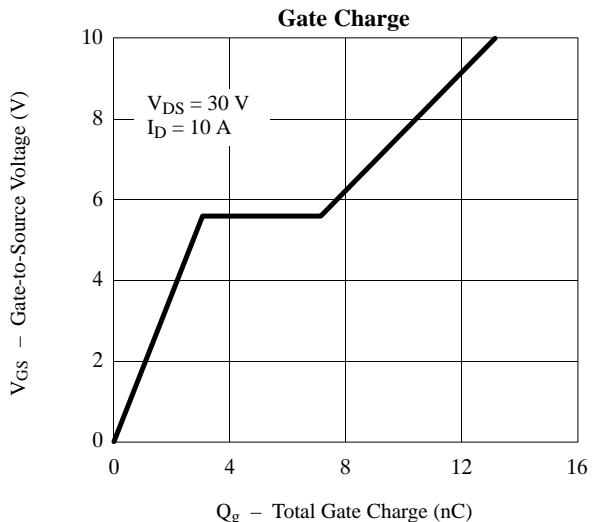
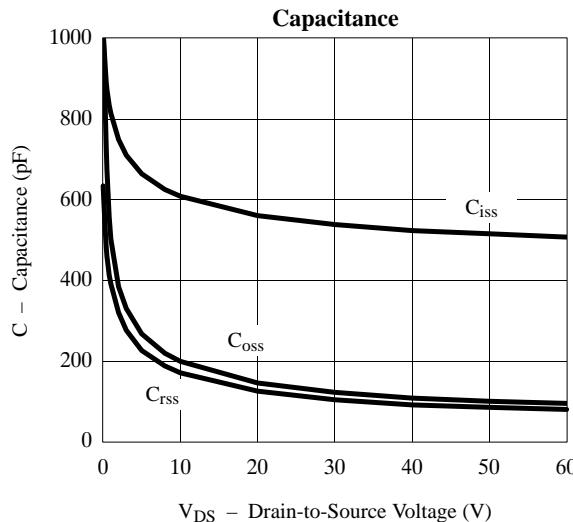
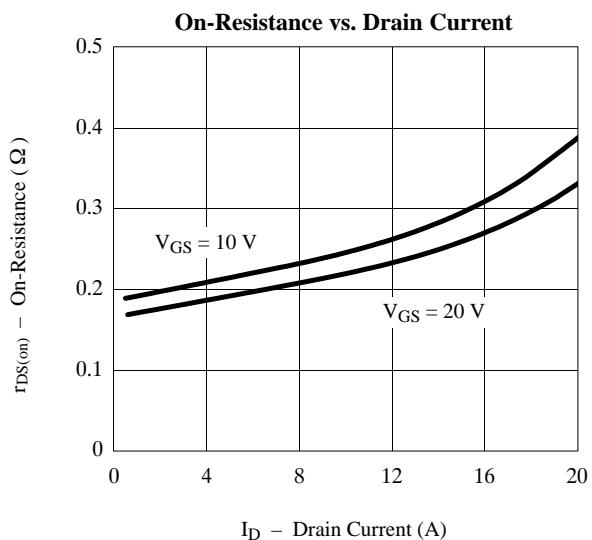
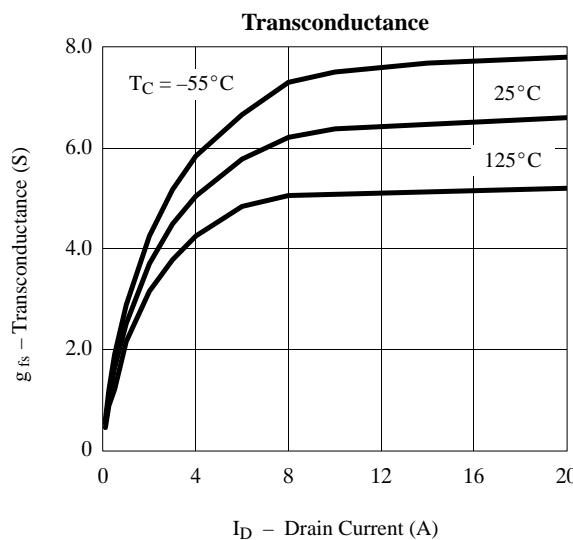
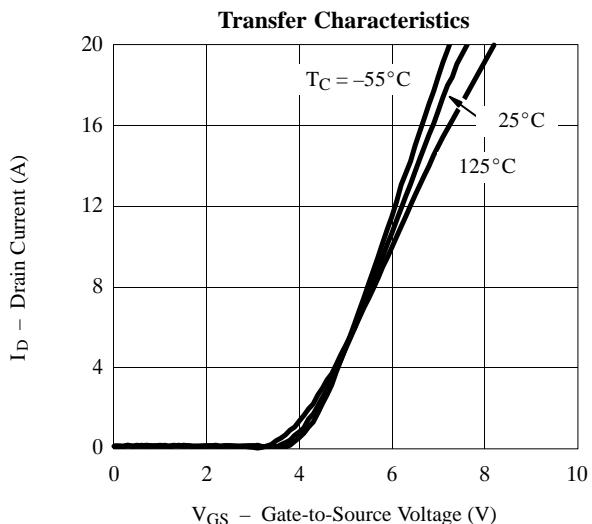
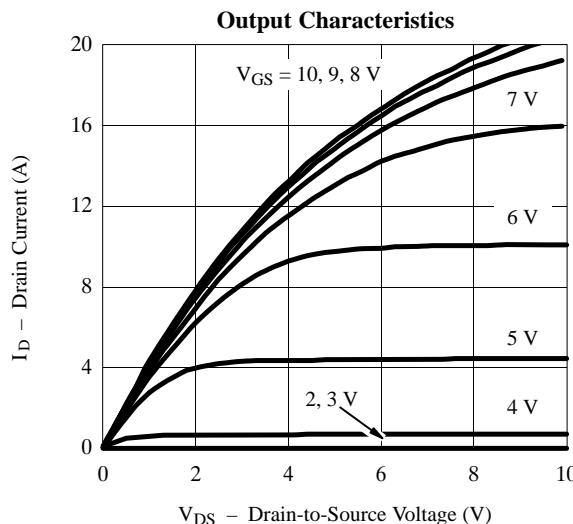
Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Test Condition | Min | Typ ^a | Max | Unit |
|-------------------------------------------------------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------|------|------------------|-----------|---------------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0 \text{ V}, I_D = -10 \mu\text{A}$ | -60 | | | V |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = -10 \mu\text{A}$ | -2.0 | | -4.0 | |
| Gate-Body Leakage | I_{GSS} | $V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = -60 \text{ V}, V_{\text{GS}} = 0 \text{ V}$ | | | -1 | μA |
| | | $V_{\text{DS}} = -60 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 125^\circ\text{C}$ | | | -50 | |
| | | $V_{\text{DS}} = -60 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 175^\circ\text{C}$ | | | -150 | |
| On-State Drain Current ^b | $I_{\text{D}(\text{on})}$ | $V_{\text{DS}} = -5 \text{ V}, V_{\text{GS}} = -10 \text{ V}$ | -10 | | | A |
| Drain-Source On-State Resistance ^b | $r_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = -10 \text{ V}, I_D = -3.0 \text{ A}$ | | | 0.28 | Ω |
| | | $V_{\text{GS}} = -10 \text{ V}, I_D = -3.0 \text{ A}, T_J = 125^\circ\text{C}$ | | | 0.46 | |
| Forward Transconductance ^b | g_{fs} | $V_{\text{DS}} = -10 \text{ V}, I_D = -5.7 \text{ A}$ | 2.3 | | | s |
| Dynamic^a | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{GS}} = 0 \text{ V}, V_{\text{DS}} = -25 \text{ V}, f = 1 \text{ MHz}$ | | 550 | 1000 | pF |
| Output Capacitance | C_{oss} | | | 130 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 110 | | |
| Total Gate Charge ^c | Q_g | $V_{\text{DS}} = -30 \text{ V}, V_{\text{GS}} = -10 \text{ V}, I_D = -10 \text{ A}$ | | 13 | 24 | nC |
| Gate-Source Charge ^c | Q_{gs} | | | 3 | 6 | |
| Gate-Drain Charge ^c | Q_{gd} | | | 4 | 8 | |
| Turn-On Delay Time ^c | $t_{\text{d}(\text{on})}$ | $V_{\text{DD}} = -30 \text{ V}, R_L = 3 \Omega$ $I_D \cong -10 \text{ A}, V_{\text{GEN}} = -10 \text{ V}, R_G = 25 \Omega$ | | 10 | 20 | ns |
| Rise Time ^c | t_r | | | 30 | 60 | |
| Turn-Off Delay Time ^c | $t_{\text{d}(\text{off})}$ | | | 38 | 70 | |
| Fall Time ^c | t_f | | | 20 | 40 | |
| Source-Drain Diode Ratings and Characteristics | | | | | | |
| Pulsed Current | I_{SM} | | | | -16 | A |
| Forward Voltage ^b | V_{SD} | $I_F = -10 \text{ A}, V_{\text{GS}} = 0 \text{ V}$ | | | -1.2 | V |
| Reverse Recovery Time | t_{rr} | $I_F = -10 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}$ | | 60 | | ns |
| Reverse Recovery Charge | Q_{rr} | | | 0.15 | | μC |

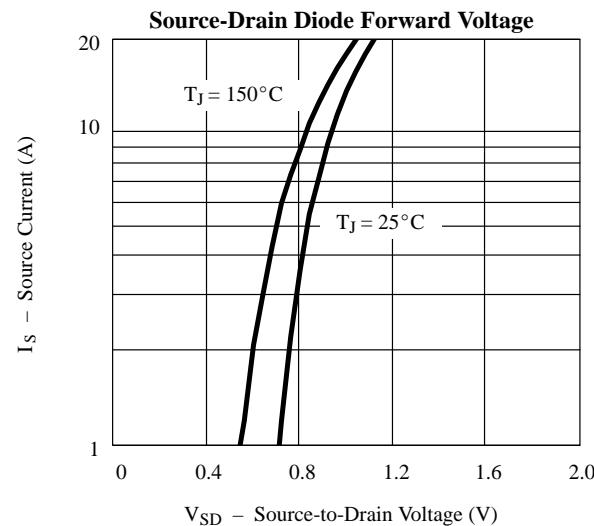
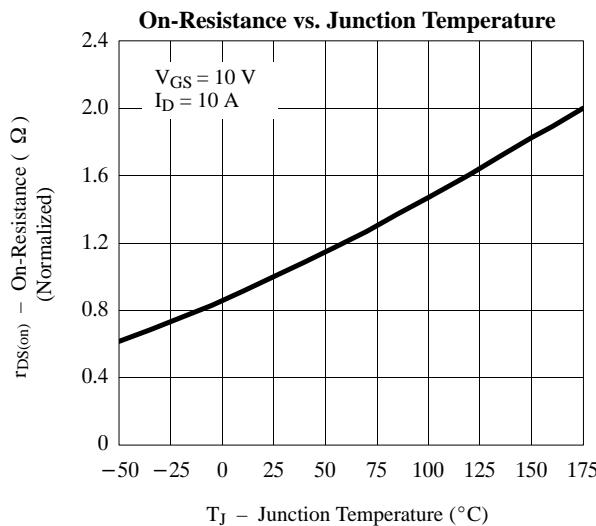
Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- c. Independent of operating temperature.

Typical Characteristics (25°C Unless Otherwise Noted)



Typical Characteristics (25°C Unless Otherwise Noted)



Thermal Ratings

